

V _{DSS}	600V
R _{DS(on)} (Max.)	0.042Ω
Ι _D	76A
P _D	120W

Features

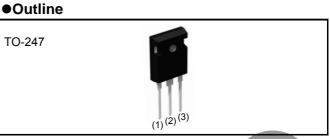
- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Gate-source voltage (V_{GSS}) guaranteed to be $\pm 20V$.
- 4) Drive circuits can be simple.
- 5) Parallel use is easy.
- 6) Pb-free lead plating ; RoHS compliant

Application

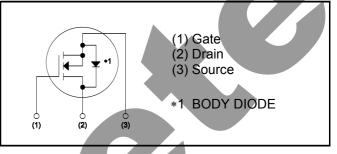
Switching Power Supply

• Absolute maximum ratings ($T_a = 25^{\circ}C$)

Parameter	Symbol	Value	Unit
Drain - Source voltage	V _{DSS}	600	V
Continuous drain current $T_c = 25^{\circ}C$	ا _D *1	±76	А
$T_c = 100^{\circ}C$	ا _D *1	±41.3	А
Pulsed drain current	I _{D,pulse} *2	±228	А
Gate - Source voltage	V _{GSS}	±20	V
Avalanche energy, single pulse	E _{AS} ^{*3}	1954	mJ
Avalanche energy, repetitive	E _{AR} ^{*3}	2.96	mJ
Avalanche current, repetitive	I _{AR}	13.4	А
Power dissipation $(T_c = 25^{\circ}C)$	P _D	120	W
Junction temperature	Тj	150	°C
Range of storage temperature	T _{stg}	–55 to +150	°C
Reverse diode dv/dt	dv/dt ^{*4}	15	V/ns



●Inner circuit



Packaging specifications

	Packaging	Tube
	Reel size (mm)	-
Type	Tape width (mm)	-
Гуре	Basic ordering unit (pcs)	450
	Taping code	C9
	Marking	R6076ENZ1

•Absolute maximum ratings

Parameter	Symbol	Conditions	Values	Unit
Drain - Source voltage slope	dv/dt	V _{DS} = 480V T _j = 125°C	50	V/ns

•Thermal resistance

Parameter	Symbol	Values			Unit
	Symbol	Min.	Тур.	Max.	Orm
Thermal resistance, junction - case	R_{thJC}	-	-	1.04	°C/W
Thermal resistance, junction - ambient	R _{thJA}	-	-	30	°C/W
Soldering temperature, wavesoldering for 10s	T _{sold}		-	265	°C

•Electrical characteristics ($T_a = 25^{\circ}C$)

Parameter	Symbol	Conditions	Values			Unit
Faranielei	Symbol	Conditions	Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 1mA	600	-	-	V
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 600V, V_{GS} = 0V$ $T_j = 25^{\circ}C$ $T_j = 125^{\circ}C$	-	0.1	100 1000	μΑ
Gate - Source leakage current	I _{GSS}	V_{GS} = ±20V, V_{DS} = 0V	-	-	±100	nA
Gate threshold voltage	V _{GS (th)}	V _{DS} = 10V, I _D = 1mA	2	-	4	V
Static drain - source on - state resistance	$R_{DS(on)}$ *5	V_{GS} = 10V, I_{D} = 44.4A T _j = 25°C T _j = 125°C	-	0.038 0.085	0.042	Ω
Gate input resistance	R _G	f = 1MHz, open drain	-	0.7	-	Ω

•Electrical characteristics (T_a = 25°C)

Deremeter	Cumphal	Conditions	Values			Upit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Transconductance	${\sf g}_{\sf fs}$ *5	V _{DS} = 10V, I _D = 38A	22.5	45.0	-	S
Input capacitance	C _{iss}	V _{GS} = 0V	-	6500	-	
Output capacitance	C _{oss}	V _{DS} = 25V	-	4700	-	pF
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	520	-	
Effective output capacitance, energy related	C _{o(er)}	V _{GS} = 0V	-	235	-	
Effective output capacitance, time related	C _{o(tr)}	V_{DS} = 0V to 480V	-	1210		pF
Turn - on delay time	t _{d(on)} *5	$V_{DD} \simeq 300 V, V_{GS} = 10 V$		65	-	
Rise time	t _r *5	I _D = 38A	-	170	-	n 0
Turn - off delay time	t _{d(off)} *5	R _L = 7.87Ω	-	450	-	ns
Fall time	t _f *5	$R_G = 10\Omega$	-	170	-	

●Gate Charge characteristics (T_a = 25°C)

Parameter	Symbol Conditions		Values			Unit
Faranielei	Symbol	Conditions	Min.	Тур.	Max.	Unit
Total gate charge	Q _g *5	V _{DD}	-	260	-	
Gate - Source charge	Q _{gs} *5	I _D = 50A	-	40	-	nC
Gate - Drain charge	Q _{gd} ^{*5}	V _{GS} = 10V	-	135	-	
Gate plateau voltage	V _(plateau)	$V_{DD} \simeq 300 V, I_D = 50 A$	-	6.0	-	V

*1 Limited only by maximum temperature allowed.

*2 $P_W \leq$ 10µs, Duty cycle \leq 1%

*3 I_D = 13.4A, V_{DD} = 50V

*4 Reference measurement circuits Fig.5-1.

*5 Pulsed

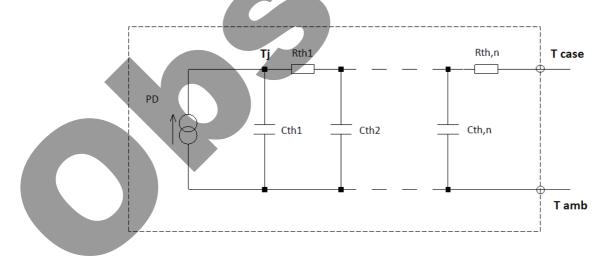
R6076ENZ1

•Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit
Faranielei	Symbol	Conditions	Min.	Тур.	Max.	Unit
Inverse diode continuous, forward current	ا _S *1	T _c = 25°C	-	-	76	А
Inverse diode direct current, pulsed	I _{SM} *2	T _c = 25 G	-	-	228	A
Forward voltage	V_{SD} *5	V _{GS} = 0V, I _S = 76A	-	-	1.5	V
Reverse recovery time	t _{rr} *5		-	990	-	ns
Reverse recovery charge	Q _{rr} ^{*5}	I _S = 76A di/dt = 100A/μs	-	32	-	μC
Peak reverse recovery current	^{*5}			65	-	А

•Typical Transient Thermal Characteristics

Symbol	Value	Unit	Symbol	Value	Unit
R _{th1}	0.0691		C _{th1}	0.0406	
R _{th2}	0.427	K/W	C _{th2}	0.873	Ws/K
R _{th3}	0.250		C _{th3}	19.9	



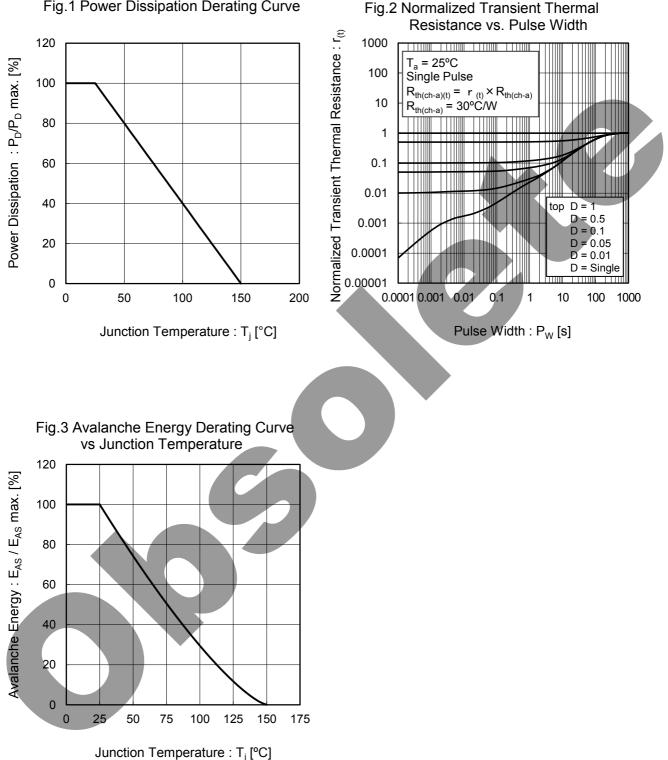


Fig.1 Power Dissipation Derating Curve

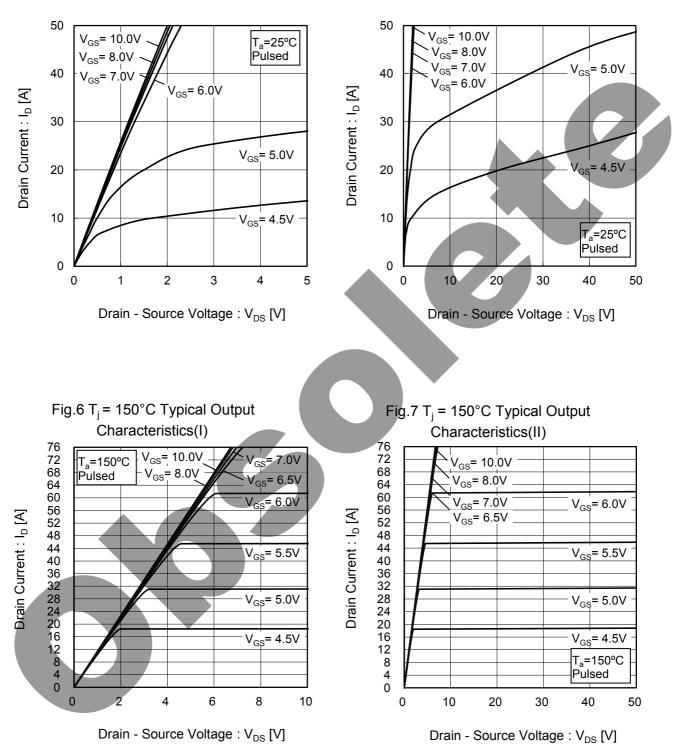
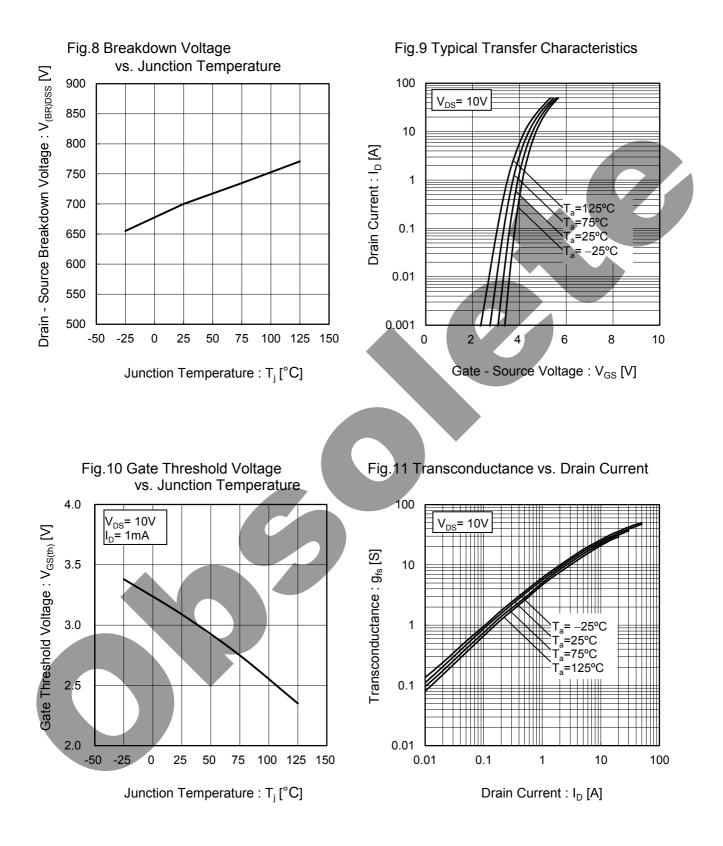
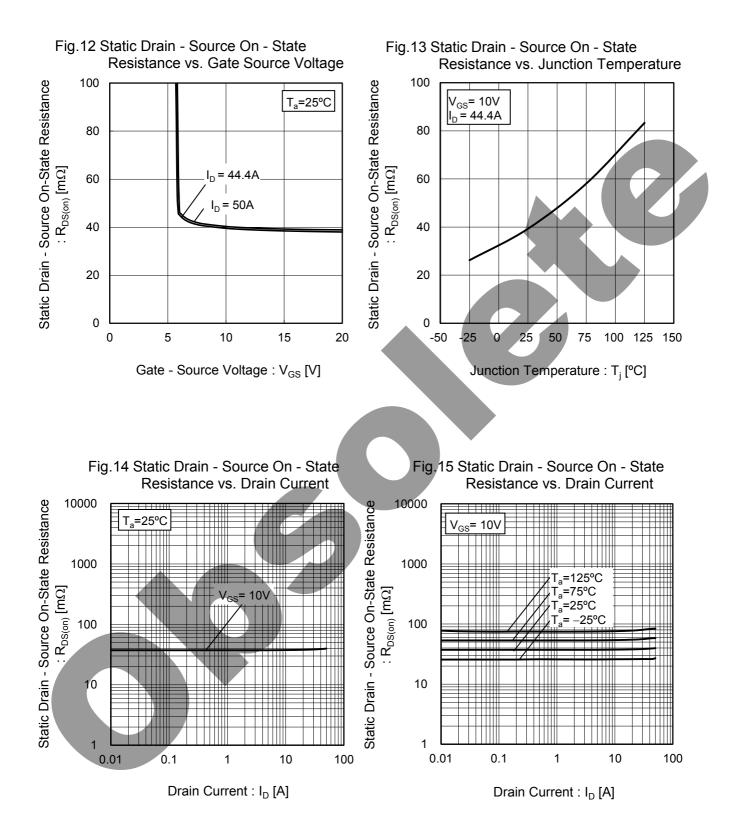
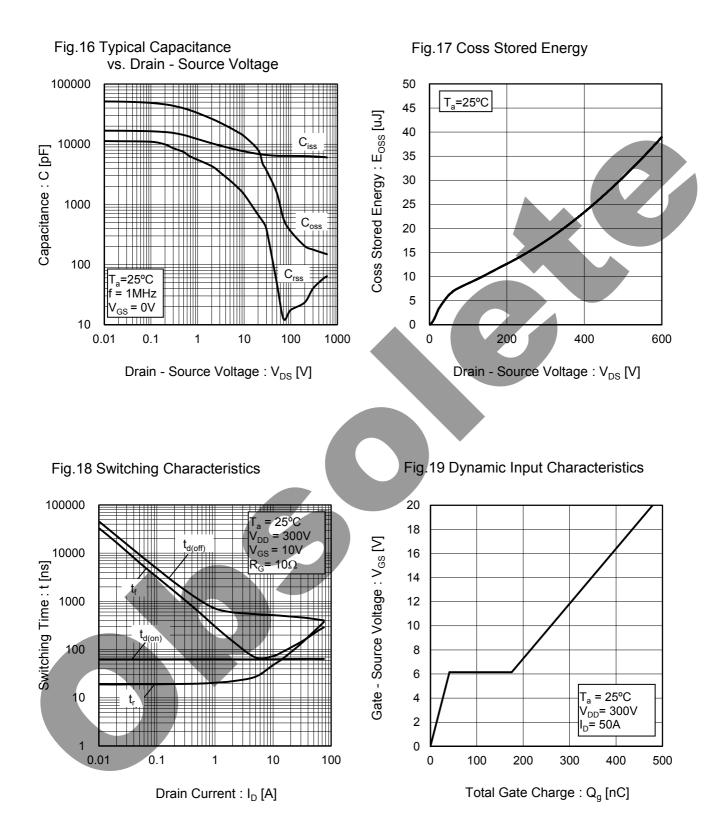


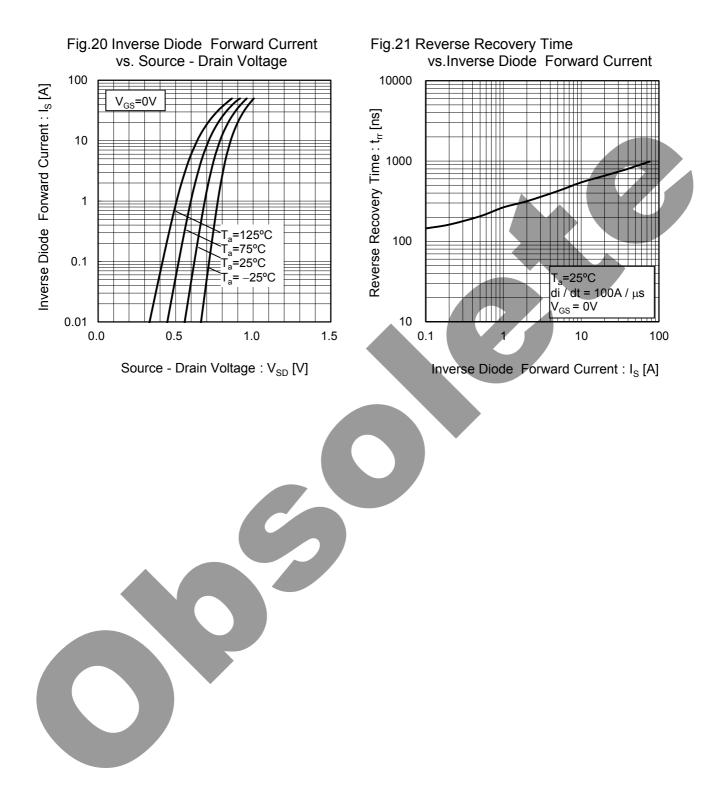
Fig.4 Typical Output Characteristics(I)

Fig.5 Typical Output Characteristics(II)

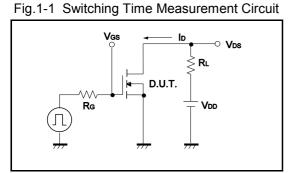








•Measurement circuits





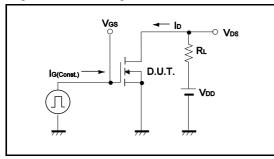


Fig.3-1 Avalanche Measurement Circuit

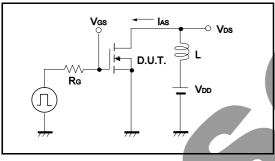


Fig.4-1 dv/dt Measurement Circuit

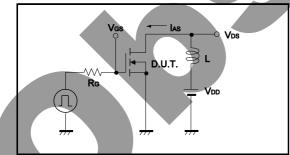
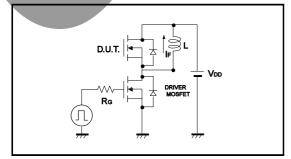


Fig.5-1 di/dt Measurement Circuit



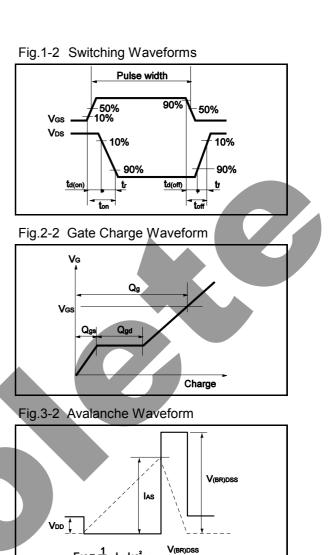
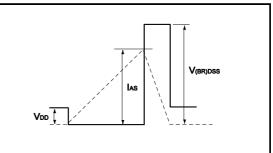


Fig.4-2 dv/dt Waveform

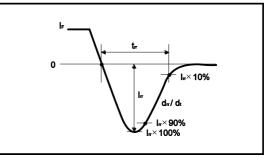
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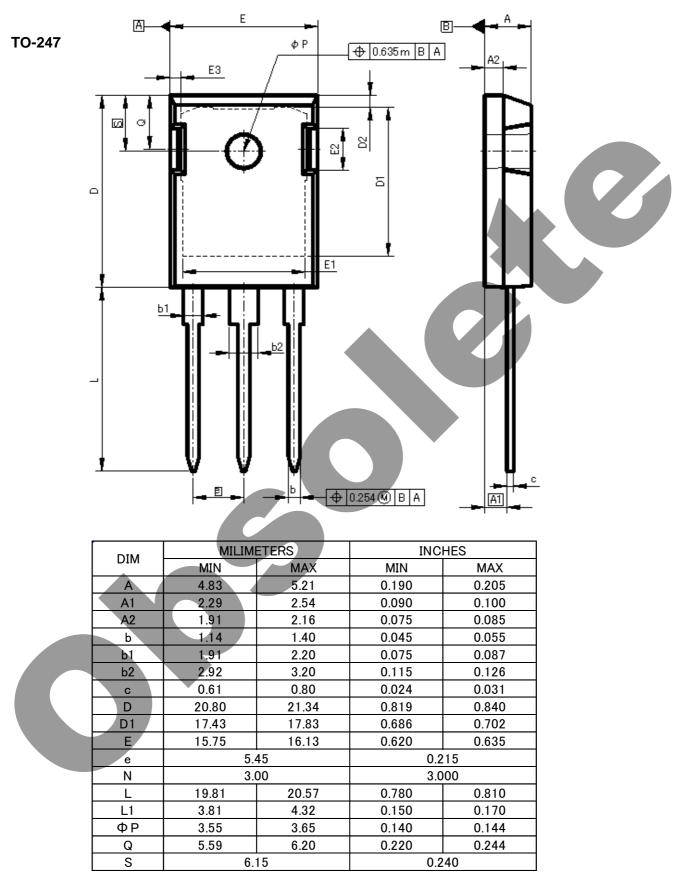


V(BR)DSS - VDD

Fig.5-2 di/dt Waveform



•Dimensions (Unit : mm)



Dimension in mm / inches

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(Note1) Medical Equipment Classification of the Specific Applications

JÁPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSII
CLASSⅣ	CLASSII	CLASSⅢ	CLASSI

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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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